TECHNOLOGY DATA SHEET & SPECIFICATIONS

MODEL: 5050SURC

Features

- InGaN Red*3 Dice LED
- Size : 5.0mm×5.0mm×1.5mm
- High luminous intensity, high reliability and long life
- With ROHS Compliant



Descriptions

- The 5050 SMD LED is much smaller than lead frame type components thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained
- Besides, lightweight makes them ideal for miniature applications.etc

Usage Notes:

- Surge will damage the LED
- When using LED, it must use a protective resistor in series with DC current about 20mA

Applications

- Amusement equipment >
- Information boards
- Flashlight for digital camera of cellular phone -
- Lighting for small size device.

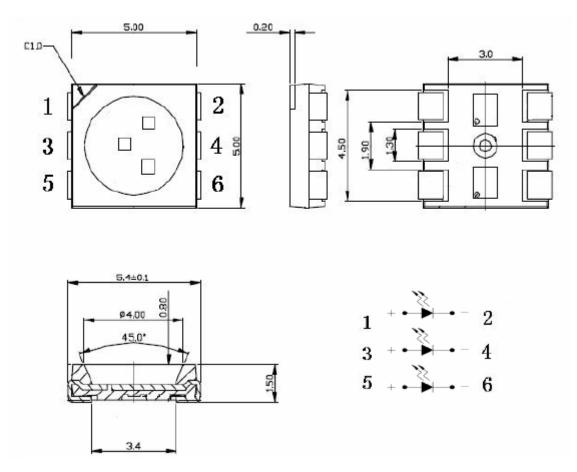
Device Selection Guide

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LED Part No.	Material	Emitted Color	Lens Color
5050SURC	InGaN	Red	Water clear

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Package Dimensions



Notes:

- Other dimensions are in millimeters, tolerance is 0.25mm except being specified.
- Protruded resin under flange is 1.5mm Max LED.
- Bare copper alloy is exposed at tie-bar portion after cutting.

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Parameter	Symbol	Absolute Maximum Rating	Unit	
Peak Forward Current		100		
(Duty 1/10 @1KHz)	I _F	100	mA	
Forward Current	I _{FM}	25	mA	
Reverse Voltage	V _R	5	V	
Power Dissipation	PD	300	mW	
Operating Temperature	Topr	-40~+80	°C	
Storage Temperature	Tstg	-40~+100	°C	
	Tsol	Reflow Soldering : 260 ℃ for 10 sec.		
Soldering Temperature		Hand Soldering : 350 $^\circ\!\mathrm{C}$ for 3 sec.		

Absolute Maximum Rating (Ta=25°C)

Electro-Optical Characteristics (T_a=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv		2000	2500	mcd	IF=20mA(Note1)
Viewing Angle	$2\theta_{1/2}$		120		Deg	(Note 2)
Peak Emission Wavelength	λp		625		nm	IF=20mA
Spectral Line Half-Width	Δλ		25	30	nm	IF=20mA
Forward Voltage	V _F	1.9		2.4	V	IF=20mA
Reverse Current	I _R			50	μΑ	VR=5V

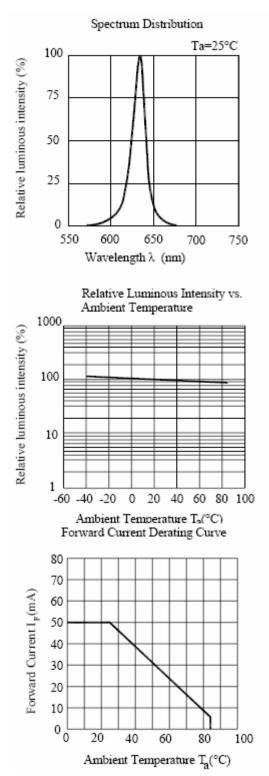
Note:

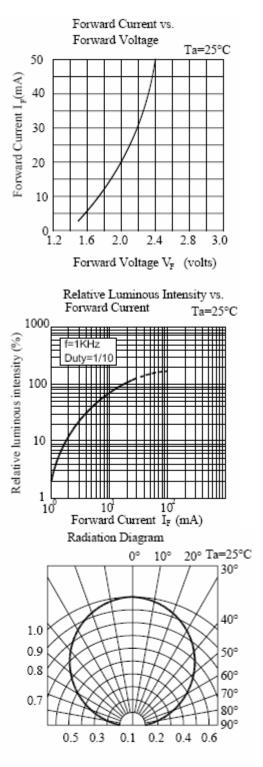
- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.

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Typical Electro-Optical Characteristics Curves





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No	Item	Test Condition	Sample Number	Criteria for Judging	Ac/Re
1	Solder ability	T=235±5°C T=5sec.	15	Good wetting	0/1
	2 Soldering heat		15	IV≥LSL*	
2		T=260 \pm 5°C T=10sec.		VF≤USL*	0/1
			IR≤USL		
		L:-40°C 10min			
Rapid change of 3 temperature followed by: damp heat, cyclic		(2~3) min			
	Danid ahanga of	H:+100°C 10min		IV≥LSL	
	5cycle	11	IV ≥LSL VF≤USL IR≤USL	0/1	
	T= (25~55) °C	11			
	RH: (90~95) %				
		2cycle 48h			
		recovery time 2h			
		T=(25~55)℃		IV≥0.7LSL	
4 Damp heat, cyclic	Damp heat cyclic	RH= (90~95) %	11	VF≤1.1USL	0/1
	Damp neat, Cyclic	6 cycle 144h	11	IR≪2USL	0/1
		recovery time 2h		IK<205L	
5 Electrical endurance	I=30mA		IV≥0.7LSL		
	F	22	VF≤1.1USL	0/1	
	T=1000h		IR≤2USL		
6 h	Storage at	$T = 100 \pm 2^{\circ}C$		IV≥LSL	
	high temperature	stg	15	VF≤USL	0/1
		t=1000h		IR≤USL	
7	Terminal strength	Tensile: W=5N t= 30s	15	No damage	0/1
	i enninai su engui	Bending: W=2.5N 2times	15		

Reliability Test Items And Conditions

*U.S.L.: Upper Standard Level

* L.S.L.: Lower Standard Level

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APPLICATION NOTES:

1)Soldering:

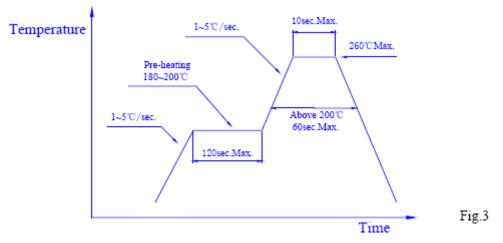
① Manual soldering by soldering iron:

The use of a soldering iron of less than 25W is recommended and the temperature of the iron must be kept at no higher than 300° C.

② Reflow soldering:

a. The temperature profile as shown in Fig. 3 is recommended for soldering SMD LED by the reflow furnace.

b. Care must be taken that the products be handled after their temperature has dropped down to the normal room temperature after soldering.



2)Post solder cleaning:

When cleaning after soldering is needed, the following conditions must be adhered to.

① Cleaning solvents: Freon TF or equivalent or alcohol.

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- ② Temperature: 50℃ Max.for 30 seconds or 30℃Max.for 3 minutes
- ③ Ultrasonic: 300W Max.
- 3) OTHERS:
- a. Care must be taken not to cause stress to the epoxy resin portion of SMD LED while it is exposed to the high temperature.

b. Care must be taken not to the rub the epoxy resin portion of SMD LED with a hard or sharp edged article such as the sand blast and the metal hook as the epoxy resin is rather soft and liable to be damaged.